Semiconductor Manufacturing International Corporation
中芯國際集成電路製造有限公司*

(Incorporated in the Cayman Islands with limited liability)

(Stock Code: 981)

ANNOUNCEMENT ON ACCEPTANCE BY THE SSE OF THE APPLICATION FOR PROPOSED RMB SHARE ISSUE UNDER THE SPECIFIC MANDATE

This announcement is made pursuant to Rule 13.09 of the Listing Rules and the Inside Information Provisions (as defined in the Listing Rules) under Part XIVA of the Securities and Futures Ordinance (Chapter 571 of the Laws of Hong Kong).

Reference is made to the announcement dated 5 May 2020 and the circular dated 9 May 2020 (the "**Circular**") of Semiconductor Manufacturing International Corporation (the "**Company**") in relation to, among other things, the Company's proposed RMB Share Issue under the Specific Mandate. Unless otherwise stated, terms defined in the Circular shall have the same meanings when used in this announcement.

The Board is pleased to announce that the Company has submitted the application materials in respect of the RMB Share Issue under the Specific Mandate to the SSE (including application proof of the prospectus (the "**Prospectus**")) and has received a letter issued by the SSE confirming acceptance of the application on 1 June 2020. The Prospectus has been published on the website for the Review and Approval of the Issuance and Listing of Stocks on the Science and Technology Innovation Board of the Shanghai Stock Exchange (上海證券交易所科創板股票發行上市審核網站) (http://kcb.sse.com.cn) on 1 June 2020, and will be published on the website of the Stock Exchange (www.hkexnews.hk) and the website of the Company (www.smics.com) pursuant to Rule 13.10B of the Listing Rules.

As the RMB Share Issue is subject to obtaining the necessary Regulatory Approvals and may or may not proceed, Shareholders and potential investors should exercise caution when dealing in the Hong Kong Shares of the Company. The Company will make further disclosures on the developments of the RMB Share Issue as and when appropriate in accordance with the Listing Rules and other applicable laws and regulations. This announcement is for information only and is not intended to and does not constitute, or form part of, an invitation or offer to acquire, purchase or subscribe for any securities of the Company.

By order of the Board
Semiconductor Manufacturing International Corporation
Gao Yonggang
Executive Director, Chief Financial Officer and Joint Company Secretary

Shanghai, PRC
1 June 2020

As at the date of this announcement, the directors of the Company are:

Executive Directors
ZHOU Zixue *(Chairman)*
ZHAO Haijun *(Co-Chief Executive Officer)*
LIANG Mong Song *(Co-Chief Executive Officer)*
GAO Yonggang *(Chief Financial Officer and Joint Company Secretary)*

Non-executive Directors
CHEN Shanzhi
ZHOU Jie
REN Kai
LU Jun
TONG Guohua

Independent Non-executive Directors
William Tudor BROWN
CONG Jingsheng Jason
LAU Lawrence Juen-Yee
FAN Ren Da Anthony
YOUNG Kwang Leei

* *For identification purposes only*